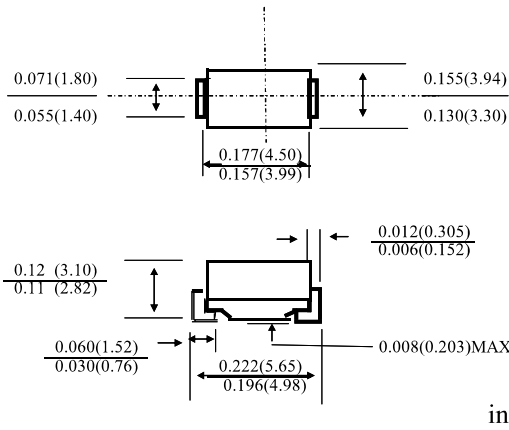


■外形尺寸和印记 Outline Dimensions and Mark  
DO - 214AA(SMB)



inch ( mm )

■特征 Features

- $I_o$  2.0A
- $V_{RRM}$  20V-100V
- 耐正向浪涌电流能力高  
High surge current capability
- 封装: 模压塑料  
Cases: Molded plastic

■用途 Applications

- 整流用 Rectifier

■极限值 (绝对最大额定值)

Limiting Values (Absolute Maximum Rating)

参数名称 Item	符号 Symbol	单位 Unit	测试条件 Test Conditions	SK 22	SK 23	SK 24	SK 25	SK 26	SK 29	SK 210		
反向重复峰值电压 Repetitive Peak Reverse Voltage	$V_{RRM}$	V		20	30	40	50	60	90	100		
正向平均电流 Average Forward Current	$I_{F(AV)}$	A	正弦半波 60Hz, 电阻负载, TL(Fig.1) 60HZ Half-sine wave, Resistance load, TL(Fig.1)	2.0								
正向 (不重复) 浪涌电流 Surge(Non-repetitive)Forward Current	$I_{FSM}$	A	正弦半波 60Hz, 一个周期, $T_a=25^\circ C$ 60Hz Half-sine wave, 1 cycle, $T_a=25^\circ C$	50								
结温 Junction Temperature	$T_J$	$^\circ C$		-55~+125			-55~+150					
储存温度 Storage Temperature	$T_{STG}$	$^\circ C$		-55 ~ +150								

■电特性 (Ta=25°C 除非另有规定)

Electrical Characteristics (Ta=25°C Unless otherwise specified)

参数名称 Item	符号 Symbol	单位 Unit	测试条件 Test Condition	SK 22	SK 23	SK 24	SK 25	SK 26	SK 29	SK 210
正向峰值电压 Peak Forward Voltage	$V_F$	V	$I_F=2.0A$	0.55			0.70		0.85	
反向漏电流 Peak Reverse Current	$I_{R1}$	mA	$V_{RM}=V_{RRM}$	$T_a=25^\circ C$		0.5			0.1	
	$I_{R2}$			$T_a=100^\circ C$		10		5.0		
热阻(典型) Thermal Resistance(Typical)	$R_{\theta J-A}$	$^\circ C/W$	结和环境之间 Between junction and ambient	75 <sup>1)</sup>						
	$R_{\theta J-L}$		结和终端之间 Between junction and terminal	17 <sup>1)</sup>						

备注: Notes:

<sup>1)</sup> 热阻从结到环境及从结到引线, 在电路板的0.3" x 0.3" (8.0毫米 x 8.0毫米)铜垫片区

Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.3" x 0.3" (8.0 mm x 8.0 mm) copper pad areas

■ 特性曲线 (典型)

图1: 正向电流降额曲线  
FIG.1: FORWARD CURRENT DERATING CURVE

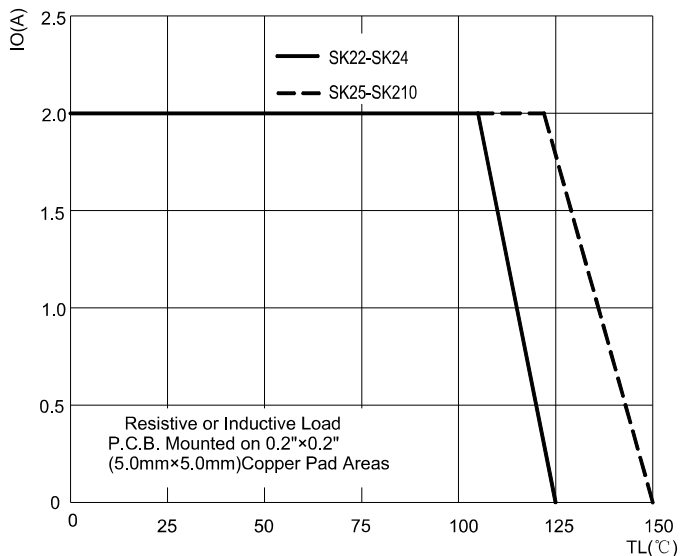


图2: 最大正向浪涌冲击耐受力  
FIG.2: MAXIMUM NON-REPETITIVE FORWARD URGE CURRENT

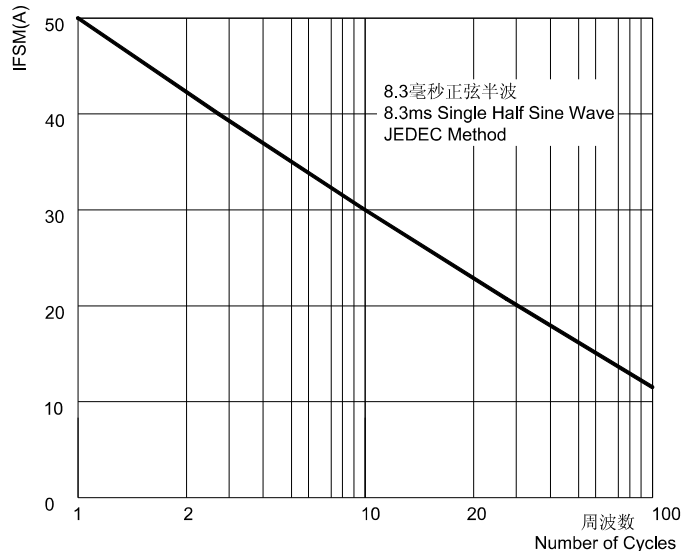


图3: 典型正向特性曲线  
FIG.3: TYPICAL FORWARD CHARACTERISTICS

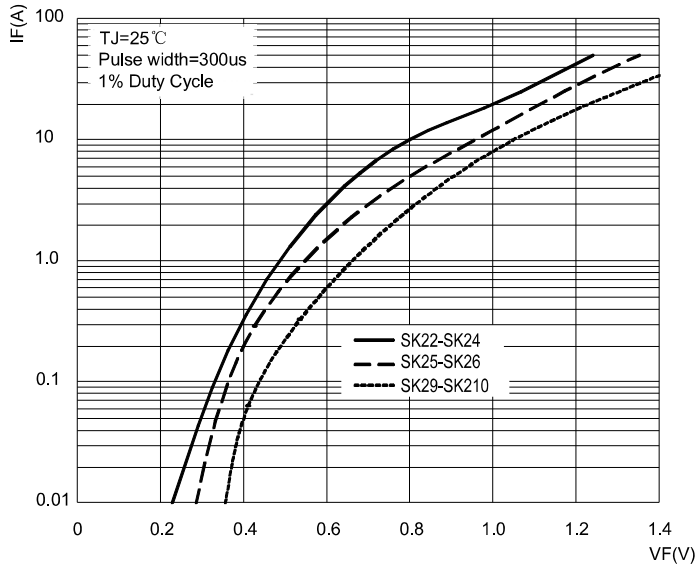


图4: 典型反向特性曲线  
FIG.4: TYPICAL REVERSE CHARACTERISTICS

